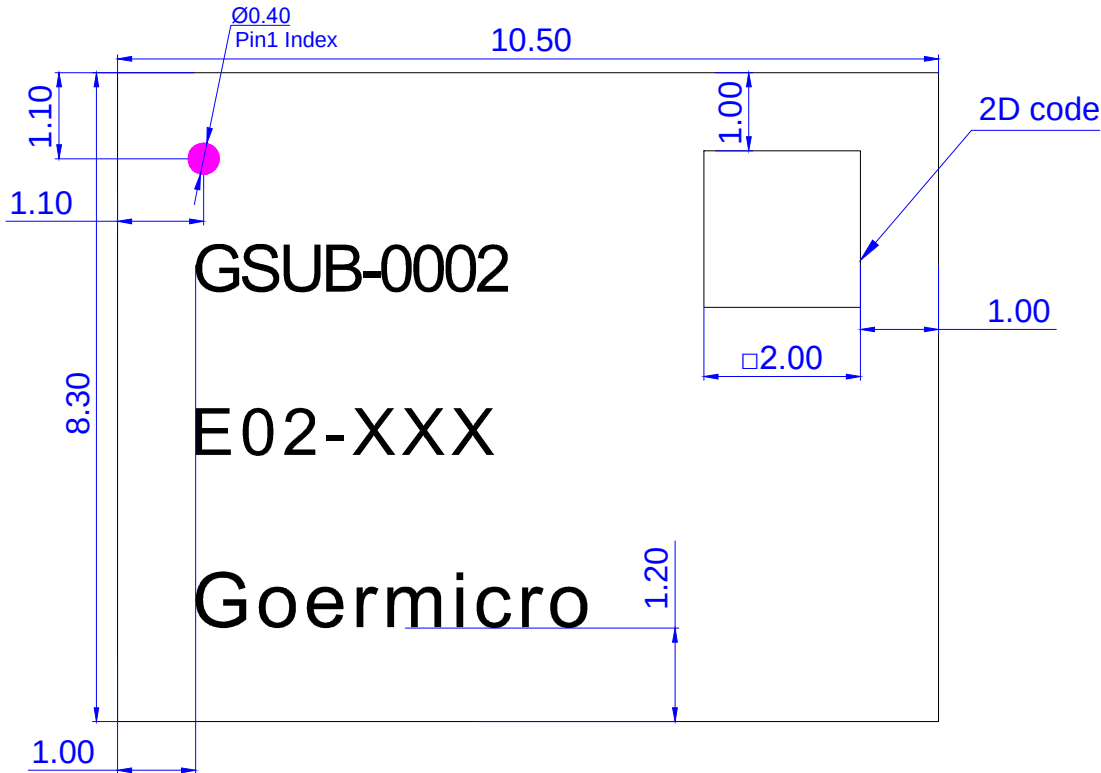




Top View (Chip Side View)

Marking	Content	Height	Font	Type
Logo	Goermicro	0.7	Arial	Laser
Projcet Name	GSUB-0002	0.6		
Version	<i>E02</i>	0.6		
Config Name	<i>XXX</i>	0.6		

2D 码详细信息:*G+1+YWWD+S+SSS+EEEE+X+SSSS+CCRR*

以（ *G+1+2044+K+001+UB02+2+00FB+010A* ）为例

G:*Goermicro*

1:*Production Line*

2044: *Date Code-- YWWD*

K:*Substrate Vendor Code*

001: *001~ZZZ(exculde I&O) , strip count in one day. Reset to 001 at the start of a new day*

UB02:*Production Name*

2:*Build Phase No.*

00FB:*Substrate Lot No*

010A:*Column(01~20)+Row(0A~0K,exculde I&O)*

Confidential		DRAWING NAME		MARKING SPECIFICATION DRAWING	
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILIMETERS TOLERANCES ARE: X. XXX ±0.025 ANGLES ±1° X. XX ±0.05 X. X ±0.10		TITLE		PKG SIZE:10.50MMX8.30MM	
		PROJECT NAME		UNIT	VERSION
		DRAWING NO.		mm	E02
		Goermicro		SHEET 2 / 2	